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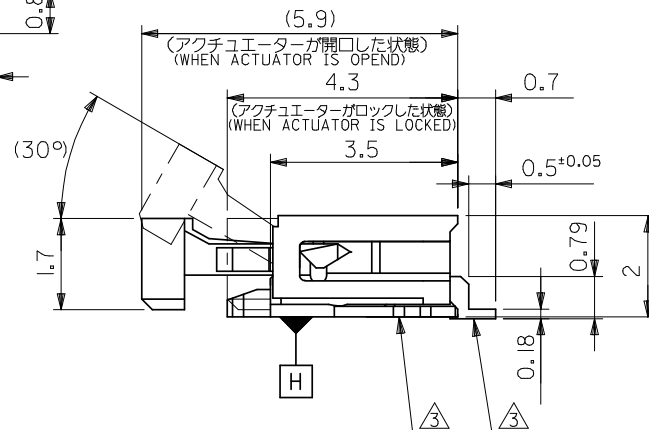
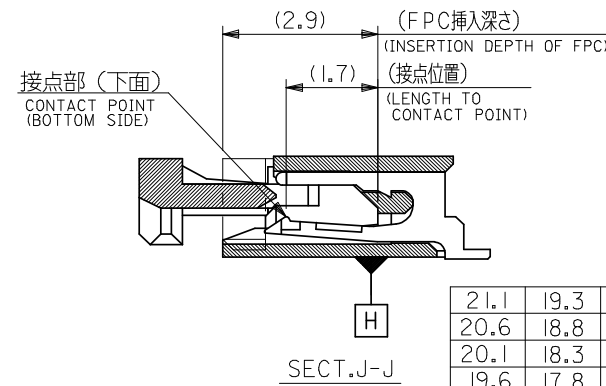
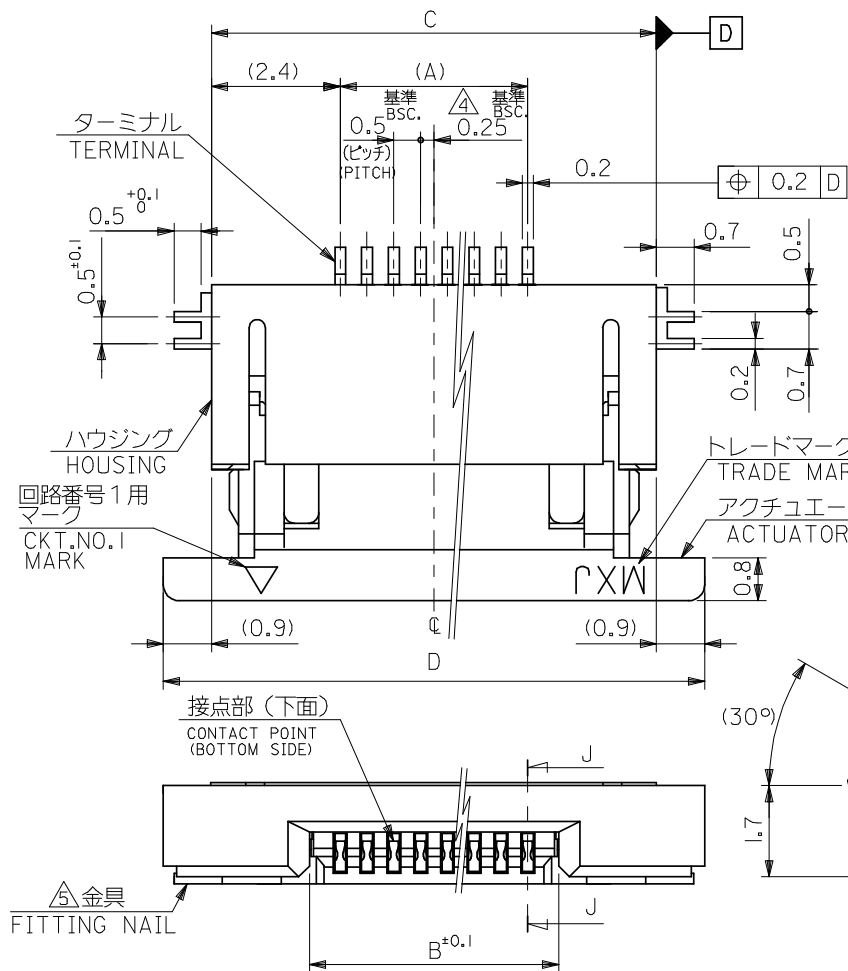
E

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21.1	19.3	15.65	14.5	52746-3070	52746-3019	30
20.6	18.8	15.15	14.0	-2970	-2919	29
20.1	18.3	14.65	13.5	-2870	-2819	28
19.6	17.8	14.15	13.0	-2770	-2719	27
19.1	17.3	13.65	12.5	-2670	-2619	26
18.6	16.8	13.15	12.0	-2570	-2519	25
18.1	16.3	12.65	11.5	-2470	-2419	24
17.6	15.8	12.15	11.0	-2370	-2319	23
17.1	15.3	11.65	10.5	-2270	-2219	22
16.6	14.8	11.15	10.0	-2170	-2119	21
16.1	14.3	10.65	9.5	-2070	-2019	20
15.6	13.8	10.15	9.0	-1970	-1919	19
15.1	13.3	9.65	8.5	-1870	-1819	18
14.6	12.8	9.15	8.0	-1770	-1719	17
14.1	12.3	8.65	7.5	-1670	-1619	16
13.6	11.8	8.15	7.0	-1570	-1519	15
13.1	11.3	7.65	6.5	-1470	-1419	14
12.6	10.8	7.15	6.0	-1370	-1319	13
12.1	10.3	6.65	5.5	-1270	-1219	12
11.6	9.8	6.15	5.0	-1170	-1119	11
11.1	9.3	5.65	4.5	-1070	-1019	10
10.6	8.8	5.15	4.0	-0970	-0919	9
10.1	8.3	4.65	3.5	-0870	-0819	8
9.6	7.8	4.15	3.0	-0770	-0719	7
9.1	7.3	3.65	2.5	-0670	-0619	6
8.1	6.3	2.65	1.5	52746-0470	52746-0419	4
D	C	B	(A)	EMBOSSED TAPE ORDER No. オーダー番号	MATERIAL NO.	極数 CIRCUITS

注記 NOTES

1. 使用材料 MATERIAL

ハウジング
HOUSING : 46ナイロン, UL94V-0
46NYLON

アクチュエータ : PPS, UL94V-0
ACTUATOR

ターミナル : リン青銅 (±0.2) ニッケル下地・鍍銀スマスマッキ
TERMINAL PHOS-BRO, TIN-BITHMUS OVER NICKEL PLATED

金具 : リン青銅 (±0.2) ニッケル下地・鍍メッキ
FITTING NAIL PHOS-BRO, TIN OVER NICKEL PLATED

2. エンボステープ梱包時は、アクチュエータがロックした状態とする。 IN THE PACKAGE, ACTUATOR OF PART NO. 52746-**19 SHOULD BE LOCKED.

△ ソルダータール半田付け面のズレ量、及び金具半田付け面のズレ量は、基準面 [H]
に対し上方向 0.1 MAX. 下方向 0.15 MAX. とする。
MISALIGNMENT OF SOLDER TAILS AND FITTING NAILS FROM [H]
UPPER DIRECTION: 0.1 MAX. , LOWER DIRECTION: 0.15 MAX.

△ 偶数極に適用。
APPLY FOR EVEN CIRCUIT.

△ パターンはくり止め用金具

FITTING NAIL FOR PREVENTION OF PEELING
OF P.C.B. PATTERN.

6 本製品は 52746-**17 の鉛フリー品です。
THIS PRODUCT IS LEAD FREE OF 52746-**17

REVISED EC NO: J2008-4308 2008/06/27 DRWN:WABEI 2008/06/30 CHK'D:THARUYAMA APPR:NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE		
				MM ONLY		---	METRIC	PROJECTION		
		10 UNDER	± 0.2	DRAWN BY T.UENO	DATE '03/12/12	TITLE 0.5 FPC CONN. ZIF SMT R/A -LEAD FREE-				
		10 OVER 30 UNDER	± 0.25	CHECKED BY M.SASAO	DATE '03/12/12					
		30 OVER	± 0.3	APPROVED BY M.SASAO	DATE '03/12/12	MOLEX MOLEX INCORPORATED				
	ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.					
REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SEE TABLE		SD-52746-028					1 OF 2	
		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

10 9 8 7 6 5 4 3 2 1

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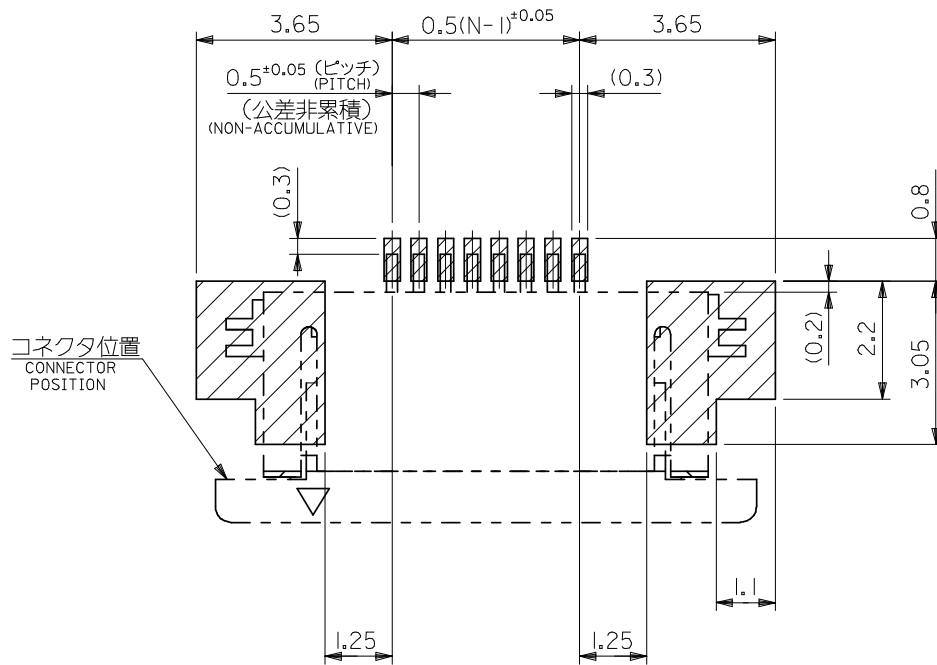
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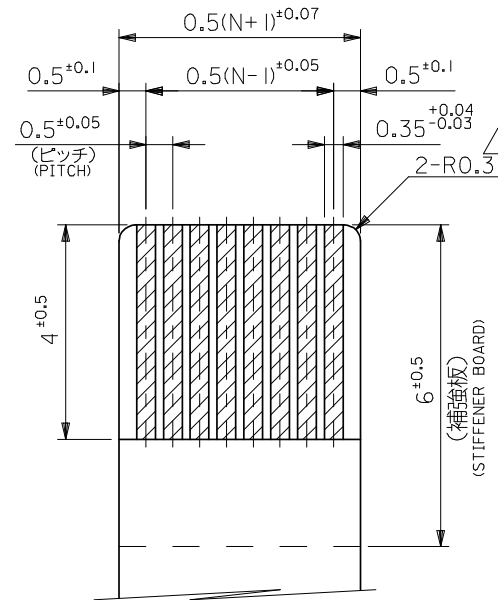
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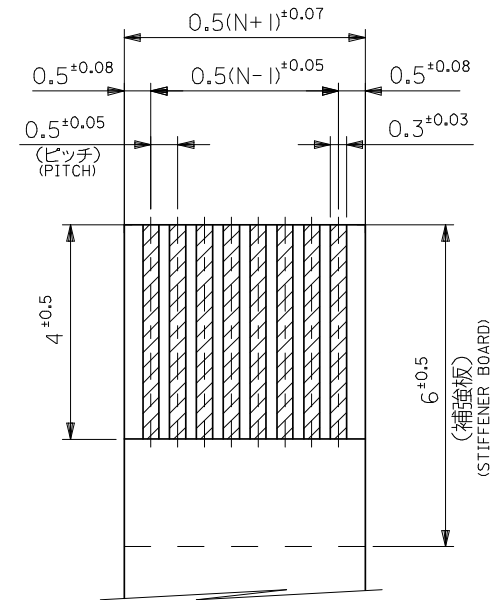
A



参考基板レイアウト
RECOMMENDED P.C.BOARD
PATTERN DIMENSION (REF.)
(マウント面)
(MOUNTING SIDE)



適合FPC推奨寸法
APPLICABLE FPC
RECOMMENDED DIMENSION
(仕上がり厚さ: 0.3±0.03)
(THICKNESS: 0.3±0.03)

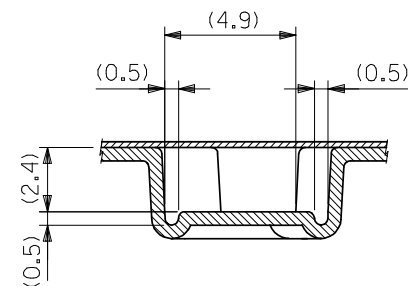
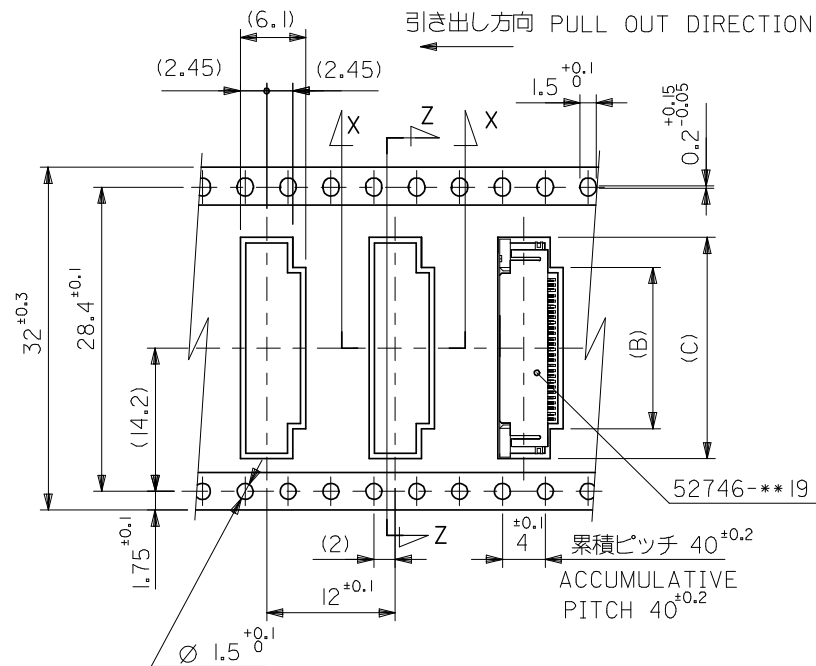
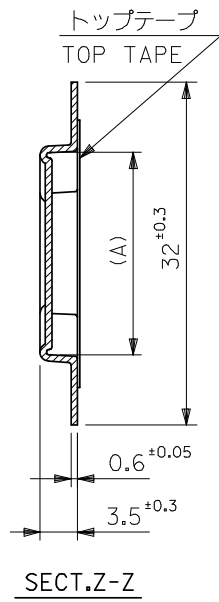


適合FFC推奨寸法
APPLICABLE FFC
RECOMMENDED DIMENSION
(仕上がり厚さ: 0.3±0.03)
(THICKNESS: 0.3±0.03)

注記 NOTES

- △ R0.3は、FPCの導体部にかからないこと。
R0.3 MUST NOT BE OVERLAPPED TO PATTERN OF FPC.
- 2 FPCについて:
打抜き方向は導体側から補強板を推奨致します。
補強フィルム材質はポリイミドを推奨致します。
接着剤は熱硬化接着剤を推奨致します。
- ABOUT FPC:
RECOMMENDED PUNCHER DIRECTION : FROM CONDUCTOR SIDE TO STIFFENER BOARD SIDE.
RECOMMENDED MATERIAL :
STIFFENER FILM : POLYIMIDE
BONDING AGENT : THERMOSETTING BONDING AGENT

REVISED EC NO: J2008-4308 DRWN:WABEI CHKD:THARUYAMA APPR:NUKITA	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	±0.2	DRAWN BY T. UENO	DATE '03/12/12	TITLE 0.5 FPC CONN. ZIF SMT R/A -LEAD FREE-				
		10 OVER 30 UNDER	±0.25	CHECKED BY M. SASAO	DATE '03/12/12					
		30 OVER	±0.3	APPROVED BY M. SASAO	DATE '03/12/12	MOLEX INCORPORATED				
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-52746-028		2 OF 2		
				THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



SECT.X-X

32mm幅キャリアテープ
32mm WIDTH CARRIER TAPE

32	37.4	33.4	22.4	15.8	21.4	52746-3070	30
			21.9	15.3	20.9	-2970	29
			21.4	14.8	20.4	-2870	28
			20.9	14.3	19.9	-2770	27
			20.4	13.8	19.4	-2670	26
			19.9	13.3	18.9	-2570	25
			19.4	12.8	18.4	-2470	24
			18.9	12.3	17.9	52746-2370	23
キャリアテープ幅 CARRIER TAPE WIDTH	E	D	(C)	(B)	(A)	MATERIAL NO.	極数 CIRCUITS

REVISED EC NO: J2008-4308 DRWN:WABEI CHKD:THARUYAMA APPR:NUKITA REV B	DESCRIPTION GENERAL TOLERANCES (UNLESS SPECIFIED) 10 UNDER ± --- 10 OVER 30 UNDER ± --- 30 OVER ± --- ANGULAR ± --- ° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DIMENSION STYLE MM ONLY DRAWN BY DATE T. UENO '03/12/12 CHECKED BY DATE M. SASAO '03/12/12 APPROVED BY DATE M. SASAO '03/12/12 MATERIAL NO. SEE TABLE SIZE A3	SCALE --- TITLE 0.5 FPC CONN ZIF SMT RA -LEAD FREE- MOLEX MOLEX INCORPORATED DOCUMENT NO. SD-52746-029	52746-**70 DESIGN UNITS METRIC THIRD ANGLE PROJECTION	MODEL NO.	SHEET NO. 3 OF 3